

4/A
12-18-01
PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Daisuke OKAMURA et al.

Serial No. (unknown)

Filed herewith

METHOD OF RECYCLING MOLD PLASTIC
PARTS FOR PHOTOSENSITIVE MATERIAL
AND A RECYCLED PLASTIC MOLD PARTS

PRELIMINARY AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Prior to the first Official Action and calculation
of the filing fee, please amend the above-identified
application as follows:

IN THE SPECIFICATION:

Please add the following paragraph between lines
16 and 17 in page 86:

A Table 4 of Fig. 7 illustrates estimations of
physical properties. The physical properties of recycled

Daisuke OKAMURA et al.

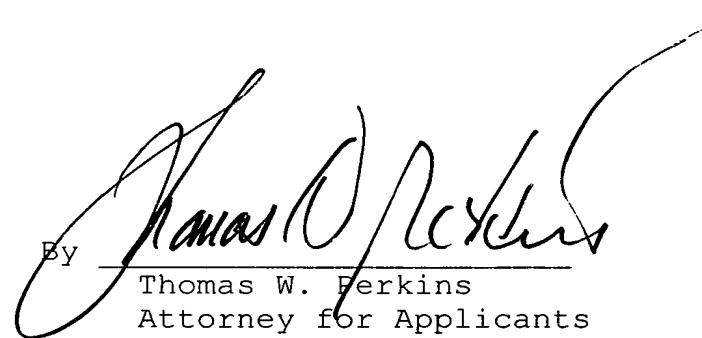
A
film units 2-5 are compared with that of a sample film unit

1. ~~etc~~

Respectfully submitted,

YOUNG & THOMPSON

By



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